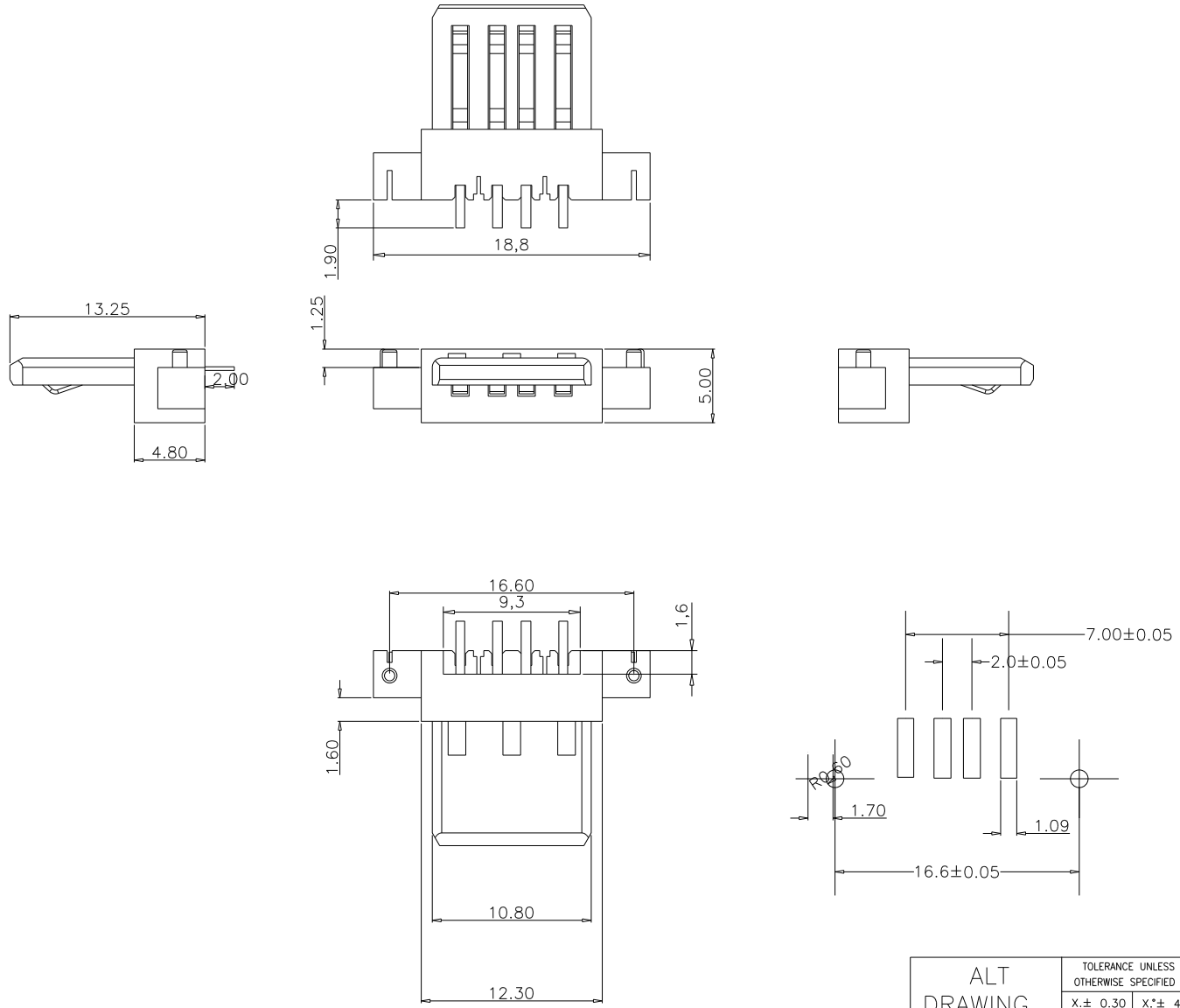


REV.	ECN NUMBER	DESCRIPTION	DRAWING	DATE



- 1)Electrical:
- 1.1 Contact Resistance: 30 mΩ Max
 - 1.2 Insulation Resistance: 1000MΩ Min
 - 1.3 Withstanding Voltage: 500V DC
 - 1.4 Current rating 1.5AMP Max.
 - 1.5 Total Mating Force: 3.57kg Max.
 - 1.6 Total Unmating force: 0.7kg Min.
 - 1.7temperature Rage: -25° +75°
- 2)Material:
- 2.1 Housing: High temperature Plastics UL94V-0
 - 2.2 SHELL: SPCC OR BRASS
 - 2.3 Contact: Brass
- 3)Finishing:
- 3.1 plating: Au or Sn Over 100u" Ni
 - 3.2 Crimp Terminal :Gold-plating
 - 3.2 Shell:Nickel-plating



ALT DRAWING		TOLERANCE UNLESS OTHERWISE SPECIFIED		<div style="text-align: center; font-weight: bold; font-size: 1.2em;"> 深圳市虹康科技有限公司 SHENZHEN HONGKANG TECHNOLOGY CO., LTD. </div>			
DRAWIN Yane		X:± 0.30	X*:± 4°				
CHECKED		.X± 0.25	.X*:± 4°	PART NO.		DWG NO.	SHK-20103
APPROVE		.XX± 0.20		TITLE	USB AF 单体超薄沉板		
DATE		UNIT	mm	PROJ.	SIZE	A4	REV. A
		SCALE	1:1				
		SHEET	1/1				